

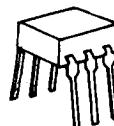
### PROGRAMMABLE THRESHOLD COUPLER

GE TYPE	PAGE NO.	ISOLATION VOLTAGE (V <sub>pk</sub> ) MIN.	CURRENT TRANSFER RATIO MIN.	I <sub>D</sub> (nA) MAX.	BV <sub>CEO</sub> (VOLTS) MIN.	TYPICAL (μSEC.)		V <sub>CE(SAT)</sub> MAX.
						T <sub>R</sub>	T <sub>F</sub>	
H11A10	1281	1500	10%	50	30	2	2	.4



### AC INPUT COUPLER

H11AA1	1289	1500	20%	100	30	2	2	.4
H11AA2	1289	1500	10%	200	30	2	2	.4



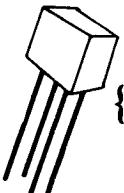
### HIGH VOLTAGE COUPLER

H11D1	1307	2500	20%	100	300	5	5	.4
H11D2	1307	1500	20%	100	300	5	5	.4
H11D3	1307	1500	20%	100	200	5	5	.4
H11D4	1307	1500	10%	100	200	5	5	.4
4N38	539	1500	10%	50	80	5	5	1.0
4N38A	539	1775 V <sub>RMS</sub>	10%	50	80	5	5	1.0



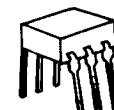
### PHOTO DARLINGTON OUTPUT

H11B1	1293	2500	500%	100	25	125	100	1.0
H11B2	1293	1500	200%	100	25	125	100	1.0
H11B3	1293	1500	100%	100	25	125	100	1.0
H11B255	1295	1500	100%	100	55	125	100	1.0
H15B1	1315	4000 V <sub>RMS</sub>	400%	100	25	125	100	1.4
H15B2	1315	4000 V <sub>RMS</sub>	200%	100	25	125	100	1.4
4N29	533	2500	100%	100	30	5	40	1.0
4N29A	533	1775 V <sub>RMS</sub>	100%	100	30	5	40	1.0
4N30	533	1500	100%	100	30	5	40	1.0
4N31	533	1500	50%	100	30	5	40	1.2
4N32	533	2500	500%	100	30	5	100	1.0
4N32A	533	1775 V <sub>RMS</sub>	500%	100	30	5	100	1.0
4N33	533	1500	500%	100	30	5	100	1.0



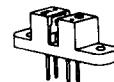
### PHOTO SCR OUTPUT

GE TYPE	PAGE NO.	ISOLATION VOLTAGE MIN.	I <sub>F</sub> TRIGGER (MAX.)	I <sub>D</sub> 100°C (MAX.) μA	BLOCKING VOLTAGE (MIN.)	TYPICAL		V <sub>F</sub> (MAX.)
						T <sub>ON</sub> (μSEC.)	t <sub>f</sub> (μSEC.)	
H11C1	1299	2500	20mA	50	200	1	1	1.5
H11C2	1299	1500	20mA	50	200	1	1	1.5
H11C3	1299	1500	30mA	50	200	1	1	1.5
H11C4	1303	2500	20mA	100	400	1	1	1.5
H11C5	1303	1500	20mA	100	400	1	1	1.5
H11C6	1303	1500	30mA	100	400	1	1	1.5
4N39	541	1500	14mA	50	200	1	1	1.5
4N40	541	1500	14mA	150	400	1	1	1.5
H74C1	1327	1500			200			
H74C2	1327	1500			400			



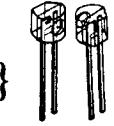
### PHOTON COUPLED INTERRUPTER MODULE

GE TYPE	PAGE NO.	OUTPUT CURRENT	I <sub>D</sub> (nA)	BV <sub>ECO</sub> (V)	TYPICAL		V <sub>CE(SAT)</sub> MAX.
					T <sub>ON</sub> (μSEC.)	t <sub>f</sub> (μSEC.)	
H13A1	1309	I <sub>F</sub> = 20mA	200μA	100	30	5	.4
H13A2	1309	I <sub>F</sub> = 20mA	50μA	100	30	5	.4
H13B1	1311	I <sub>F</sub> = 20mA	2500μA	100	25	150	1.2
H13B2	1311	I <sub>F</sub> = 20mA	1000μA	100	25	150	1.2



### MATCHED Emitter DETECTOR PAIRS

H17A1	1317	I <sub>F</sub> = 20mA	50μA	100	30	5	5	.4
H17B1	1319	I <sub>F</sub> = 20mA	1000μA	100	25	150	150	1.2
H19A1	1321	I <sub>F</sub> = 20mA	100μA	100	30	5	5	.4
H19B1	1325	I <sub>F</sub> = 20mA	2000μA	100	25	150	150	1.2





# Photon Coupled Isolator H11B1-H11B2-H11B3

## Ga As Infrared Emitting Diode & NPN Silicon Photo-Darlington Amplifier

The General Electric H11B1, H11B2 and H11B3 are gallium arsenide, infrared emitting diodes coupled with a silicon photodarlington amplifier in a dual in-line package.

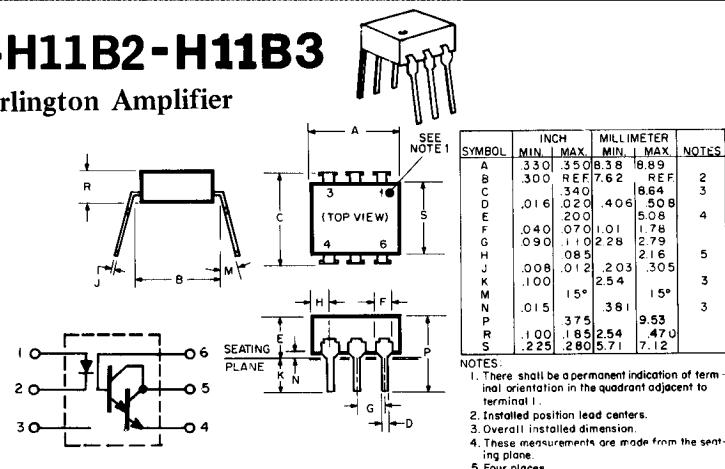
### absolute maximum ratings: (25°C)

INFRARED EMITTING DIODE		
Power Dissipation	*100	milliwatts
Forward Current (Continuous)	60	millamps
Forward Current (Peak)	3	ampere
(Pulse width 1 $\mu$ sec 300 P Ps)		
Reverse Voltage	3	volts

\*Derate 1.33mW/°C above 25°C ambient.

PHOTO-DARLINGTON		
Power Dissipation	**150	milliwatts
V <sub>CEO</sub>	25	volts
V <sub>CBO</sub>	30	volts
V <sub>ECO</sub>	7	volts
Collector Current (Continuous)	100	millamps

\*\*Derate 2.0mW/°C above 25°C ambient.



### TOTAL DEVICE

Storage Temperature -55 to 150°C

Operating Temperature -55 to 100°C

Lead Soldering Time (at 260°C) 10 seconds

Surge Isolation Voltage (Input to Output).

H11B1	2500V <sub>(peak)</sub>	1770V <sub>(RMS)</sub>
H11B2, B3	1500V <sub>(peak)</sub>	1060V <sub>(RMS)</sub>

Steady-State Isolation Voltage (Input to Output).

H11B1	1500V <sub>(peak)</sub>	1060V <sub>(RMS)</sub>
H11B2, B3	950V <sub>(peak)</sub>	660V <sub>(RMS)</sub>

### individual electrical characteristics (25°C)

INFRARED EMITTING DIODE	TYP.	MAX.	UNITS
Forward Voltage H11B1, B2 ( $I_F = 10\text{mA}$ )	1.1	1.5	volts
H11B3 ( $I_F = 50\text{mA}$ )	1.1	1.5	volts
Reverse Current ( $V_R = 3\text{V}$ )	—	10	microamps

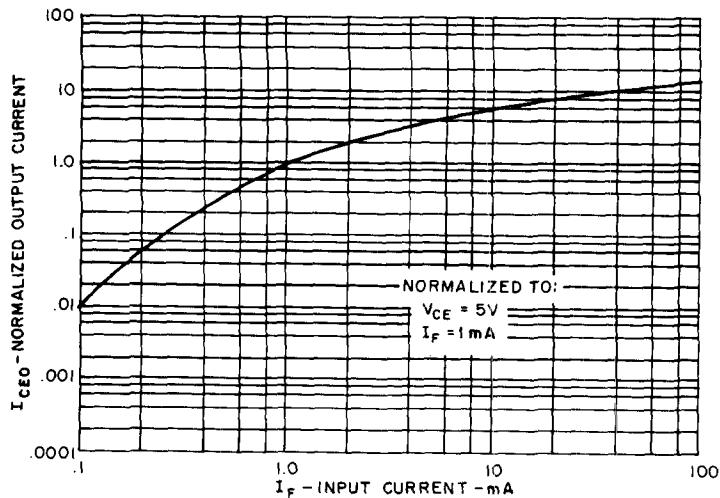
PHOTO-TRANSISTOR	MIN.	TYP.	MAX.	UNITS
Breakdown Voltage – V <sub>(BR)CEO</sub> ( $I_C = 10\text{mA}$ , $I_F = 0$ )	25	—	—	volts
Breakdown Voltage – V <sub>(BR)CBO</sub> ( $I_C = 100\mu\text{A}$ , $I_F = 0$ )	30	—	—	volts
Breakdown Voltage – V <sub>(BR)ECO</sub> ( $I_E = 100\mu\text{A}$ , $I_F = 0$ )	7	—	—	volts
Collector Dark Current – I <sub>CEO</sub> ( $V_{CE} = 10\text{V}$ , $I_F = 0$ )	—	5	100	nanoamps
Capacitance ( $V = 0, f = 1\text{MHz}$ )	—	6	—	picofarads

### coupled electrical characteristics (25°C)

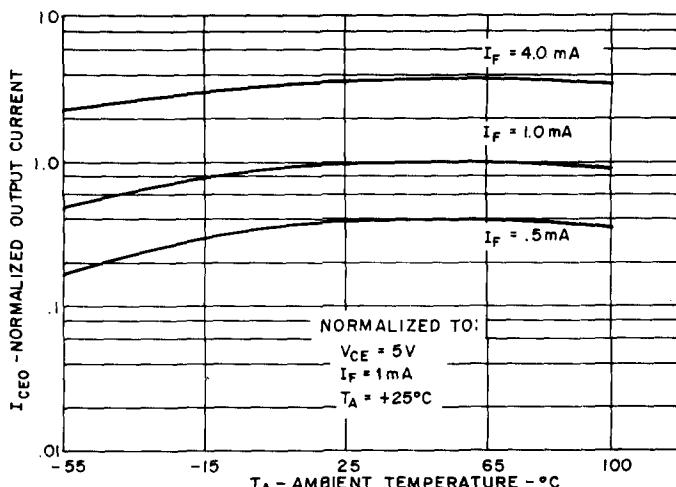
DC Current Transfer Ratio ( $I_F = 1\text{mA}$ , $V_{CE} = 5\text{V}$ )	H11B1	MIN.	TYP.	MAX.	UNITS
	H11B2	500	—	—	%
	H11B3	200	—	—	%
Saturation Voltage – Collector to Emitter ( $I_F = 1\text{mA}$ , $I_C = 1\text{mA}$ )	100	—	—	—	%
Isolation Resistance (Input to Output Voltage = 500V <sub>DC</sub> )	—	0.7	—	1.0	volts
Input to Output Capacitance (Input to Output Voltage = 0, f = 1MHz)	100	—	—	—	gigaohms
Switching Speeds: ( $V_{CE} = 10\text{V}$ , $I_C = 10\text{mA}$ , $R_L = 100\Omega$ )	On-Time	—	125	—	picofarads
	Off-Time	—	100	—	microseconds

H11B1, H11B2, H11B3

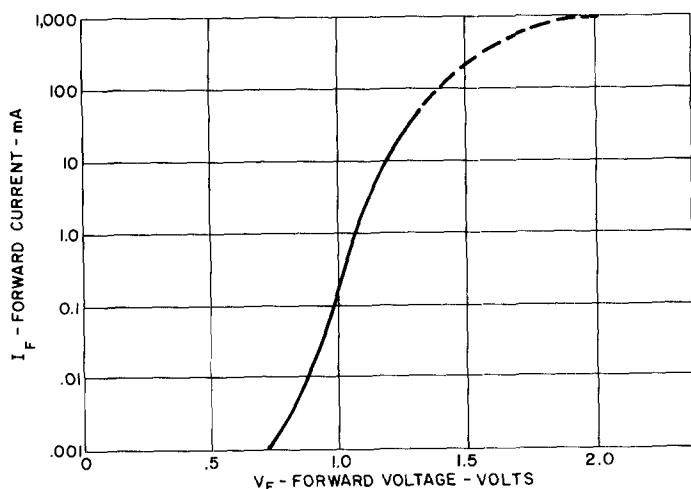
## TYPICAL CHARACTERISTICS



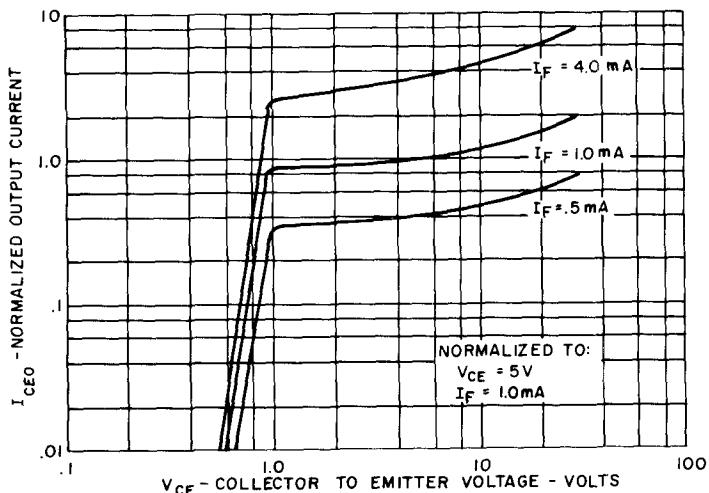
OUTPUT CURRENT VS INPUT CURRENT



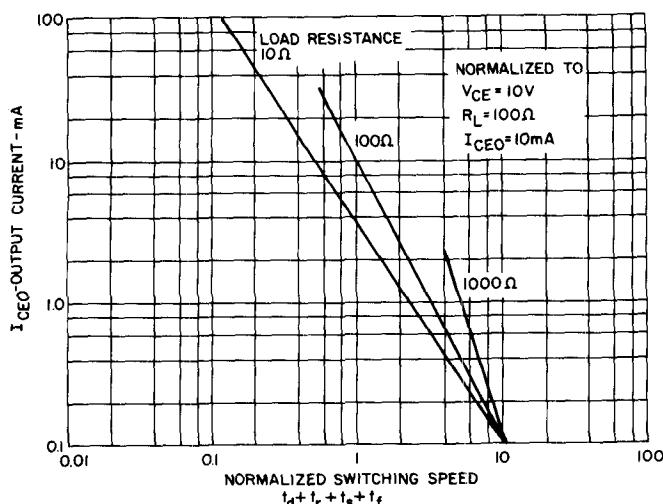
OUTPUT CURRENT VS TEMPERATURE



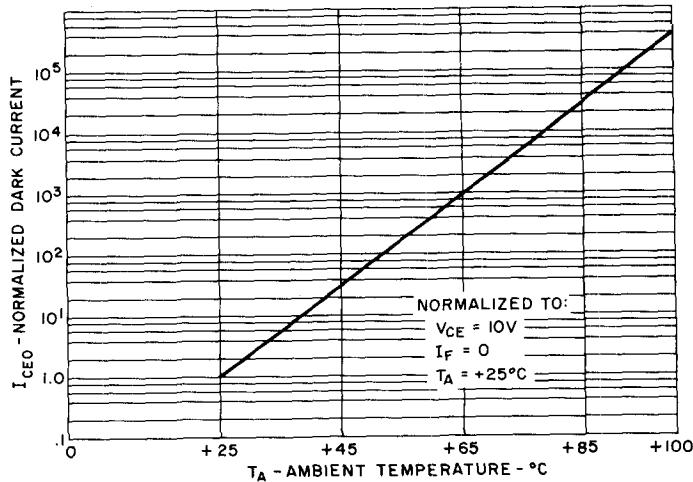
INPUT CHARACTERISTICS



OUTPUT CHARACTERISTICS



SWITCHING SPEED VS OUTPUT CURRENT



NORMALIZED DARK CURRENT VS TEMPERATURE